



- Note:
- Material:
    - Housing: High temperature thermoplastic with g.f,UL94v-0
    - Contact: copper alloy,t=0.20mm Gold Flash Plated over all NICKEL 30u<sup>3</sup>MIN UNDER PLATING OVER ALL.
    - Shell: SUS304,t=0.25mm MATTE NICKEL 50u<sup>3</sup>MIN PLATED OVERALL.
  - Specification:
    - Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
    - Dielectric withstanding voltage: 100 V(ac) for 1 min.
    - Contact resistance: 30 mΩ Max.
    - Insulation resistance: 100 MΩ Min.
    - Total mating force: 3.57 Kgf Max.
    - Total unmating force: 1.0 Kgf Min.
    - Temperature range: -30°C~80°C

PART NAME	CONNECTOR		DRAWING	Y,C,ZHANG	DWG.No.	SBICL
PART NO.	Micro usb 5s B 180D SMT		CHECK	G.C.Chen	REV.	A1
UNIT : mm	TOLERANCE	UP TO 5 ABOVE 5~30 ABOVE 30 ANGLE	±0.2 ±0.3 ±0.5 ±3	APPROVAL	DATE	
	OTHERWISE			SCALE	PAGE	1 OF 1